

BRCs008N04SSL

Rev.C Jan.-2026

描述 / Descriptions

LFPAK5×6 封装 N 沟道场效应管。

N-Channel MOSFET in a LFPAK5×6 Plastic Package.

特征 / Features

$V_{DS}(V)=40V$ $I_D=300A$

$R_{DS(ON)}@10V \leq 0.85m\Omega$ (Typ. $0.75m\Omega$)

$R_{DS(ON)}@4.5V \leq 1.45m\Omega$ (Typ. $1.15m\Omega$)

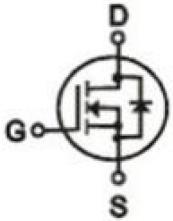
无卤产品。HF Product.

用途 / Applications

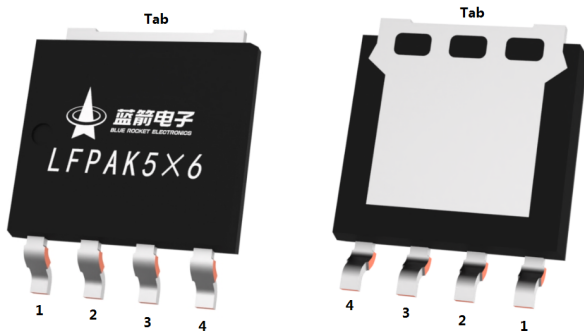
电机驱动器，DC - DC 转换器。

Motor drivers, DC - DC Converter.

内部等效电路 / Equivalent Circuit



引脚排列 / Pinning



PIN1、2、3: S PIN4: G Tab: D

印章代码 / Marking

见印章说明。

See Marking Instructions.

极限参数 / Absolute Maximum Ratings(T_a=25°C)

参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current ^{①③}	I _D (T _C =25°C)	300	A
	I _D (T _C =100°C)	300	A
Drain Current – Pulsed ^{①②}	I _{DM} (T _C =25°C)	1200	A
Power Dissipation ^①	P _D (T _C =25°C)	375	W
Operating and Storage Temperature Range	T _J , T _{stg}	-55 to 175	°C
Diode Forward Current	I _S (T _C =25°C)	300	A
Single Pulsed Avalanche Energy(V _{DD} =40V,L=1.0mH) ^①	E _{AS}	1512	mJ
Thermal resistance, junction – ambient ^①	R _{θJA}	60	°C/ W
Thermal resistance, junction – case ^①	R _{θJC}	0.4	

Note:

1. Surface Mounted on 1 in² pad area, t ≤ 10 sec
2. Pulse width ≤ 300 μs, duty cycle ≤ 2 %
3. limited by bonding wire

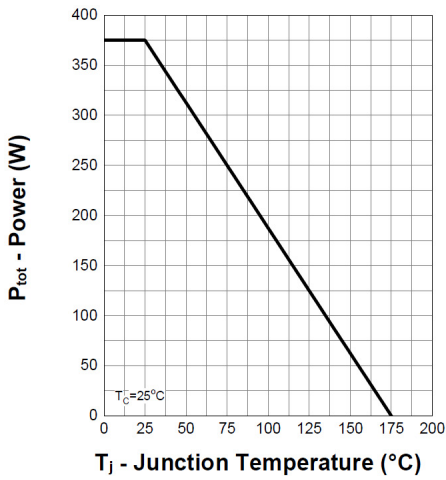
电性能参数 / Electrical Characteristics(T_a=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} I _D =250μA	1.0		2.0	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =32V V _{GS} =0V			1	μA
Gate-Body Leakage Current Forward	I _{GSS}	V _{GS} =±20V V _{DS} =0V			±0.1	μA
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V I _D =30A		0.75	0.85	mΩ
		V _{GS} =4.5V I _D =20A		1.15	1.45	mΩ
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V I _S =30A			1.3	V
Reverse Recovery Time	t _{rr}	I _{DS} = 30 A, V _{GS} = 0 V dI _{SD} /dt = 100 A/μs		33		nS
Reverse Recovery Charge	Q _{rr}			21		nC
Input Capacitance	C _{iss}	V _{DS} =20V V _{GS} =0V f=1.0MHz		14406		pF
Output Capacitance	C _{oss}			1043		
Reverse Transfer Capacitance	C _{rss}			369		

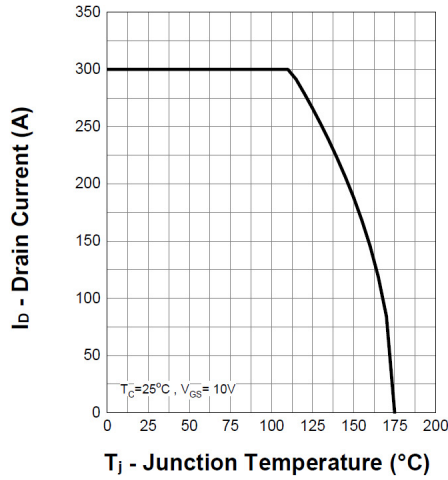
电性能参数 / Electrical Characteristics(Ta=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Turn-On Delay Time	$t_{d(on)}$	$V_{GEN}=10V$ $V_{DS}=20V$ $R_L=0.66\Omega$ $R_G=3.9\Omega$ $I_{DS}=30A$		20		ns
Turn-On Rise Time	t_r			76		
Turn-Off Delay Time	$t_{d(off)}$			222		
Turn-Off Fall Time	t_f			105		
Total Gate Charge	Q_g	$V_{GS}=10V$ $V_{DS}=20V$ $I_D=30A$		263		nC
Gate Source Charge	Q_{gs}			51		
Gate Drain Charge	Q_{gd}			38		

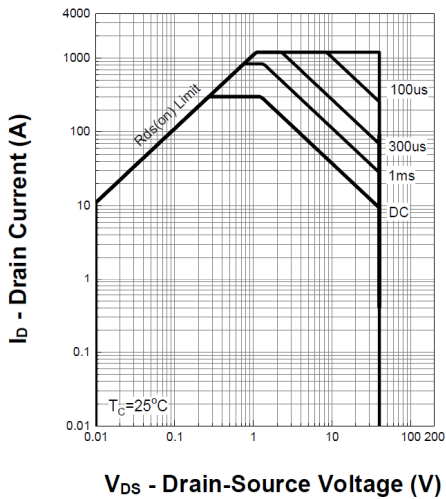
电参数曲线图 / Electrical Characteristic Curve



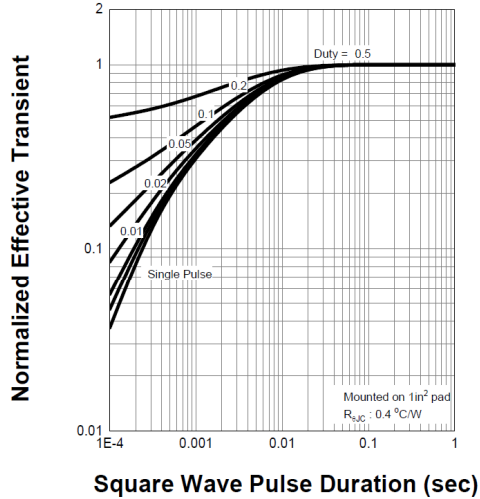
1. Power Capability



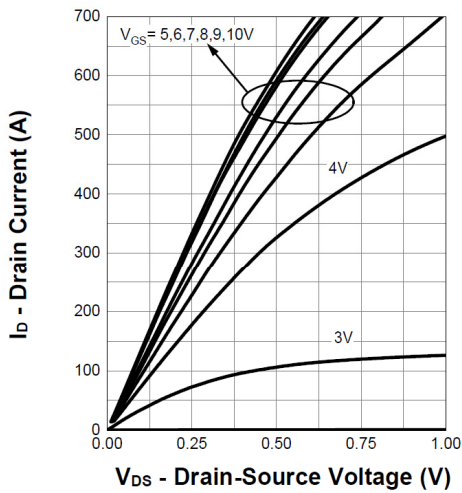
2. Current Capability



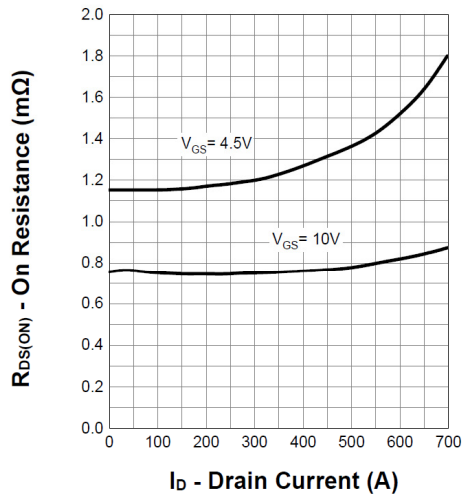
3. Safe Operating Area



4. Transient Thermal Impedance

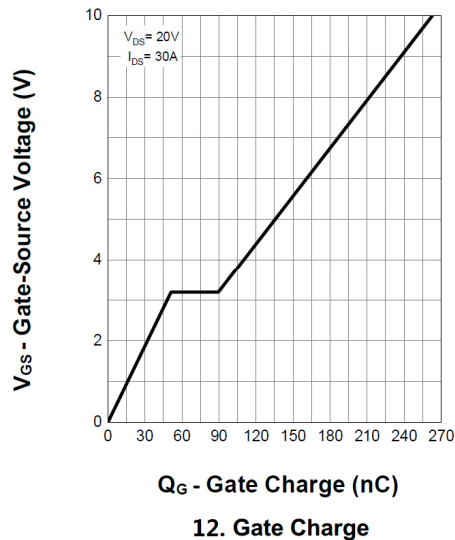
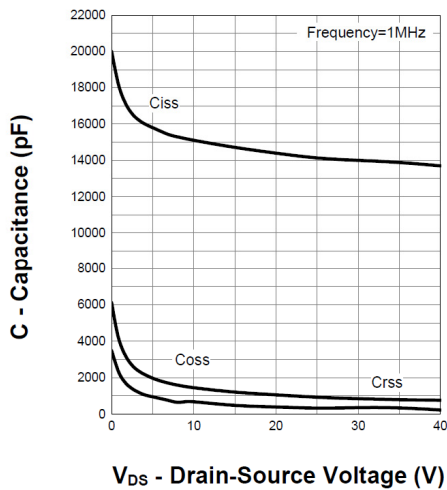
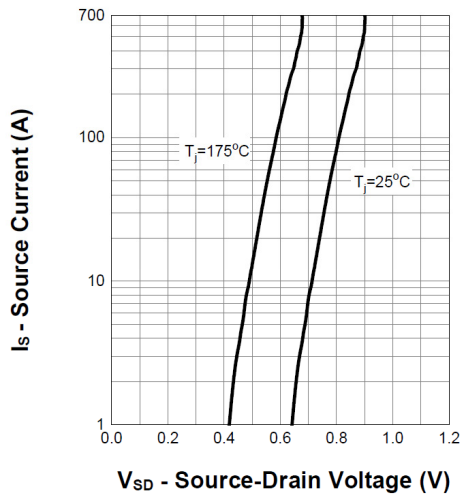
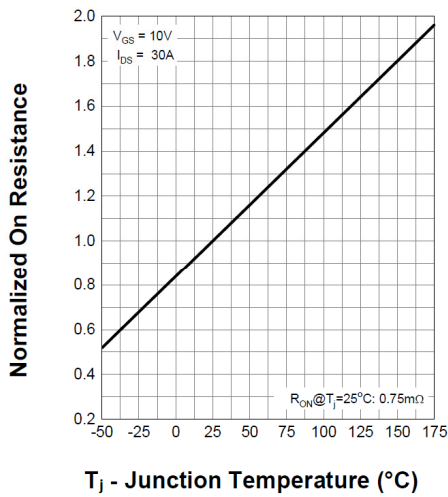
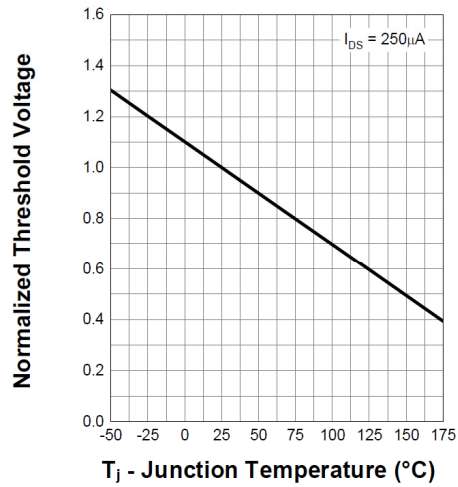
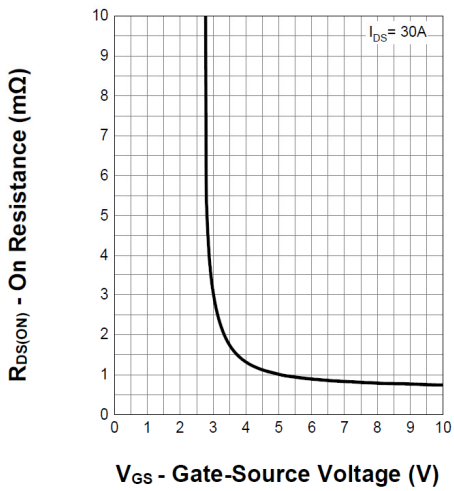


5. Output Characteristics

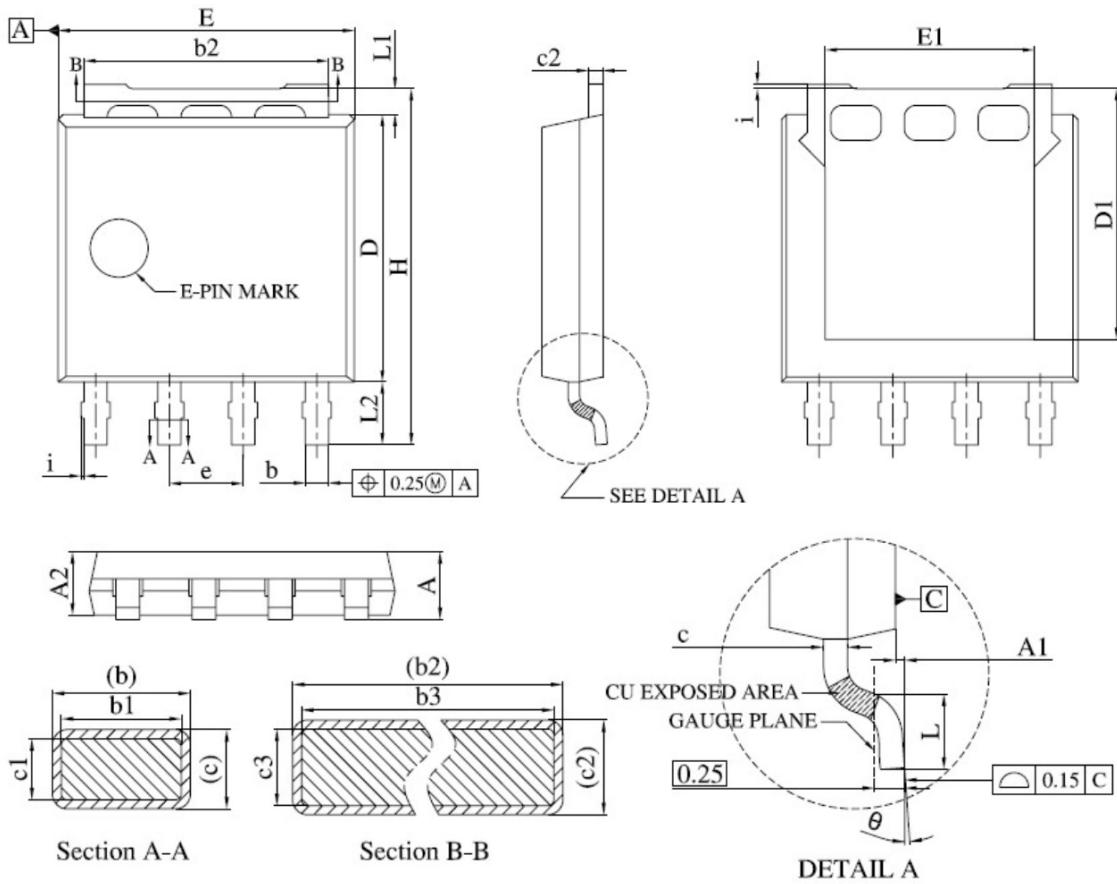


6. On Resistance

电参数曲线图 / Electrical Characteristic Curve



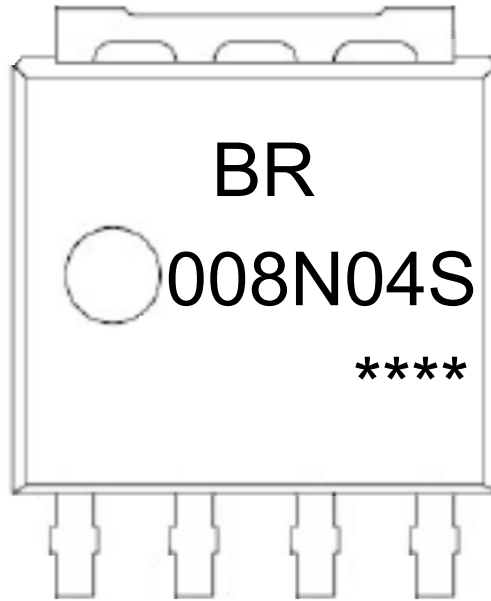
外形尺寸图 / Package Dimensions



Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	1.00	1.30
A1	0.00	0.15
A2	0.98	1.12
b	0.35	0.50
b1	0.32	0.46
b2	4.02	4.41
b3	4.00	4.37
c	0.19	0.25
c1	0.17	0.23
c2	0.24	0.30
c3	0.22	0.28
D	4.45	4.70
D1	-	4.45

Symbol	Dimensions In Millimeters	
	MIN.	MAX.
E	4.95	5.30
E1	3.50	3.70
e	1.27 BSC.	
H	5.95	6.25
i	-	0.25
L	0.40	0.85
L1	0.27	0.57
L2	0.80	1.30
θ	0°	8°

印章说明 / Marking Instructions



说明：

BR： 为公司代码

008N04S： 为型号代码

****： 为生产批号代码，随生产批号变化

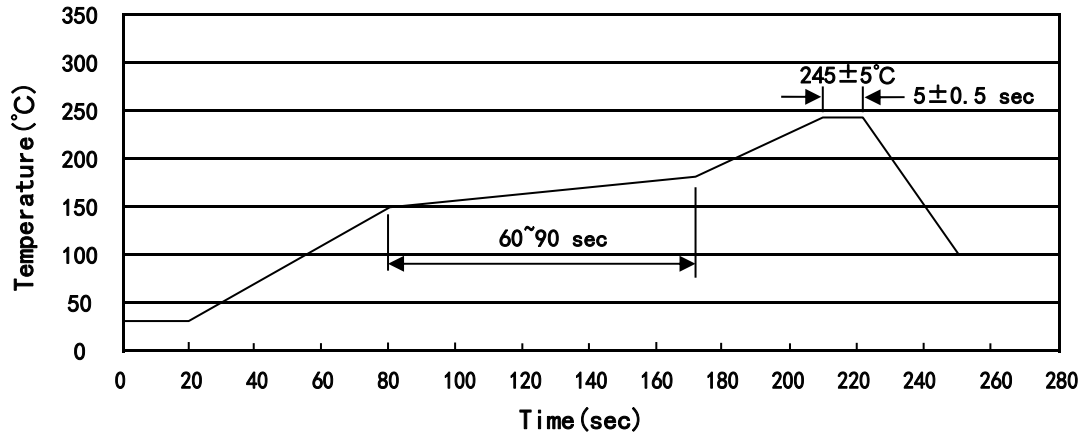
Note：

BR: Company Code

008N04S: Product Type Code

****: Lot No. Code, code change with Lot No.

回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)



说明：

- 1、预热温度 150~180°C，时间 60~90sec;
- 2、峰值温度 245±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2~10°C/sec.

Note:

- 1.Preheating:150~180°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
LFPAK5×6	3,000	2	6,000	5	30,000	13"×12	356×335×50	385×285×358

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
LFPAK5×6	5,000	2	10,000	5	50,000	13"×12	356×335×50	385×285×358

使用说明 / Notices

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